



Product Specification

TUDI-MAX487E

Low-Power, Slew-Rate-Limited RS485/RS422 Transceivers

网址 www.sztdbdt.com Q

用芯智造・卓越品质

semiconductor device manufacturer

- Design
- research and development
- production
- and sales



FEATURES

- Thermal shutdown protection;
- ●Low-Current Shutdown Mode;
- True Fail-Safe Receiver;
- Excellent noise immunity;
- ●250kbps in Electrically NoisyEnvironments;
- Hot-Swap Input Structures on DE and/RE;
- ●5V Power Supply, Half-duplex;
- allows up to 32 transceivers on the bus;
- Short-circuit protection;

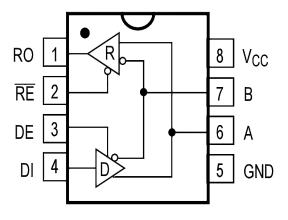


Figure 1. Pin Diagram

Description

The MAX487E is a low-power, RS-485 and RS-422 transceiver for harsh environments. driver output and receiver input is protected with ±15kV ESD (electrostatic discharge) protection that will not latch up. These parts contain one driver and one. The MAX487E has a reduced rise-rate driver that minimizes EMI and reduces reflections due to cable improper termination, thus allowing error-free data transmission up 250kbps. These transceivers consume only 120µA of supply current with the drivers disabled and the line fully loaded. Additionally, the MAX47E has a low-current shutdown mode in which they only consume 0.5µA. All parts operate from a single 5V power supply. The short-uit current is limited, and thermal shutdown circuitry is protected, forcing the outputs into a high-impedance state to prevent excessive power dissipation. The receiver inputs have a failsafe feature that guarantees the output to be logic high if they are open . The MAX487E has a quarter-unit load receiver input impedance, allowing up to 18 transceivers on the bus. The MAX487E is designed for half-duplex applications.

FUNCTION TABLES

		TRANSM	ITTING		RECEIVING				
CTR -	/RE	×	х	0	1	0	0	0	1
	DE	1	1	0	0	×	Х	Х	х
INPUTS	DI	1	0	х	х				
	A-B					≥-10mV	≤-200mV	Open/shorted	х
	А	Н	L	Z					
OUTPUTS	В	L	Н	Z					
	RO					Н	L	Н	Z
X:Don't care;Z:high impedance.									



Pin description

Pin Number Pin Name		FUNCTION				
1	RO	Receiver Output.When enabled,ifA-B≥-10mV,then RO=high.lfA-B ≤-200 mV,then RO=low				
Receiver Output Enable. Alow level enables the RO;a high level p a high impedance state.						
3 1)F		Driver Output Enable.A high level enables the driver differential outputs,Pin A and Pin B;a low level places the driver in a high impedance state.				
4 DI		Driver Input.When the driver is enabled,a logic low on DI forces Pin A low and Pin B high;a logic high on DI forces PinA high and Pin B low.				
5	GND	Ground Connection (0V).				
6 A		No inverting Receiver Input A/Driver Output A				
7	В	Inverting Receiver Input B/Driver Output B.				
8 VCC Power Supply		Power Supply				

Parameter limit

PARAMETER	Symbol	Value	Unit
CTR Port	/RE,DE,DI	-0.3~VCC+0.3	V
Driver Output Voltage	A、B	-7~13	V
Receiver Output Voltage	RO	-0.3~VCC+0.3	V
Supply Voltage	VCC	+7	V
Continuous Power Dissipation	MSOP8.SOP8.DIP8	830	mW
Soldering Temperature (reflow)		300	℃
Storage Temperature Range		-60~150	°C
Temperature Range		-40~85	°C

Stresses beyond those listed under "Parameter limit" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
	SW	/ITCHING CHARACTERISTIC	S OF RECEIVER			
Receiver Enable to Output Low	tRZL	CL=100 pF, S1closed		20	50	ns
Receiver Enable to Output High	tRZH	CL=100 pF, S2 closed		20	50	ns
Receiver Disable Time from Low	tRLZ	CL=100 pF,		20	50	ns
Receiver Disable Time from High	tRHZ	CL=100pF, S2 closed		20	50	ns
Receiver Propagation Delay (low to high)	tRPLH	Fig 7 and 8		50	200	ns
Receiver Propagation Delay (high to low)	tRPHL	VD≥2.0V; Rise and fall time		50	200	ns
tRPLH-tRPHL	tsKEW2	VID≤15ns			15	ns
	S	WITCHING CHARACTERISTI	CS OF DRIVER		- 1	/ \
Driver Enable to Output High	tDzH	CL=100 pF,			70	ns
Driver Enable to Output Low	tDzL	S1 closed (Fig 5,6)	nicor	nduci	70	ns
Driver Disable Time from Low	tDLz	CL=15 pF, S2 closed			70	ns
Driver Disable Time from High	tDHZ	(Fig 5,6)			70	ns
Driver Propagation Delay(low to high)	tDPLH			60		ns
Driver Propagation Delay (high to low)	tDPHL	RDIFF=54Ω,		60		ns
tDPLH-tDPHL	tsKEW1	CLi=CL₂=100pF (Fig 3,4)		5	±10	ns
Driver Differential Output Rise or Fall Time	tDR,tDF			40		ns



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS			
SUPPLY CURRENT									
	lcc1	/RE=0V or VCC, DE=0V		200	500	uA			
Supply Current	lcc2	/RE=VCC, DE=VCC		300	600	uA			
	lcc₃	/RE=0, DE=VCC		0.5	10	uA			
	DC EI	LECTRICAL CHARACTERISTIC	S OF RECEIVER						
Receiver Input Resistance	RN	-7V≤VcM≤12V	12			kΩ			
Receiver Output Short-Circuit	IosR	0V≤Vo≤VCC	±7		±95	mA			
RO Output-Low Voltage	VoL	IouT=+4mA, VID=-200 mV			0.4	V			
Three-State Output Current at Receiver	lozR	0.4V <vo<2.4v< td=""><td>-1</td><td>/ [</td><td>±1</td><td>uA</td></vo<2.4v<>	-1	/ [±1	uA			
Receiver Input Hysteresis	Vhys	-7V≤VCM≤12V		30	—	mV			
RO Output-High Voltage	VoH	IoUT=-4mA, VID=+200 mV	3.5			V			
Positive-going input threshold voltage	VIT+	-7V≤VcM≤12V	mico	nduc	-10	mV			
Negative-going input threshold voltage	VIT-	-7V≤VcM≤12V	-200			mV			
In mark Comment (A.P.)	INIO	DE=0V, VCC=0 or 5V			1.0	mA			
Input Current(A,B)	IN2	DE=0V, VCC=0 or 5V	0.8		mA				

NOTE

If no special situation occurs , VCC=5V±5% , Temp=T^MIN~T^MAX , typically VCC=+5V , Temp = 25



PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
DC ELECTRICAL CHARACTERISTICS OF DRIVER								
Input High Voltage	VH	DE,DI,/RE	2.0			V		
Input Low Voltage	Vn	DE,DI,/RE			0.8	V		
Input Current (RE,DI,/RE)	IN1	DE,DI,/RE	-2		2	uA		
Thermal-Shutdown Threshold				150		°C		
Thermal-Shutdown Hysteresis				20		°C		
Differential Driver Output(no load)	VoD1			5		V		
Differential Driver	VoD2	Fig 2,RL=27Ω	1.5		VCC	V		
Output	VODZ	Fig 2,RL=50	2		VCC	V		
Change in Magnitude of Differential Output Voltage (NOTE1)	△VoD	Fig 2,RL=27Ω	7 \	/ [0.2	/-v		
Driver Common-Mode Output Voltage	Voc	Fig 2,RL=27Ω			3	V		
Change In Magnitude of Common- Mode Voltage (NOTE1)	△Voc	Fig 2,RL=27Ω			0.2	V		
Driver Short-Circuit Output Current (short to high)	losD₁	Short to 0V~12V	35	nduc	250	mA		
Driver Short-Circuit Output Current (short to low)	losD2	Short to-7V~0V	-250	1000	-35	mA		

TEST CIRCUIT

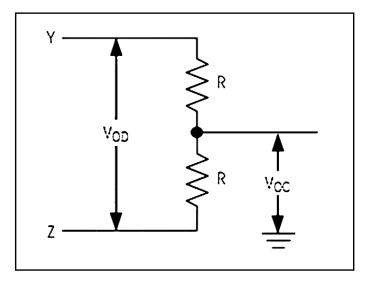


Fig 2 Driver DC Test Load

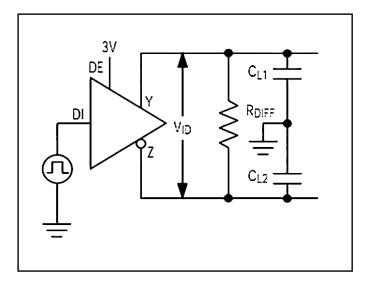
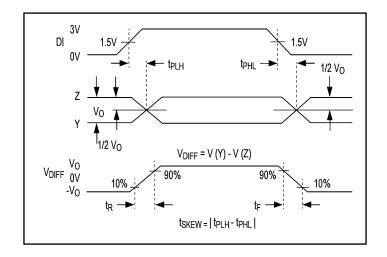


Fig 3 Driver Timing Test Circuit





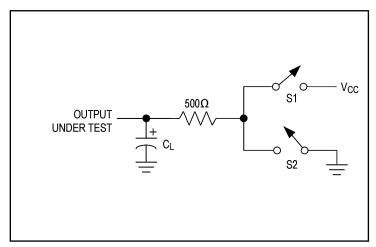


Fig 4 Driver Propagation Delays

Fig 5 Driver Enable/Disable Timing Test Load

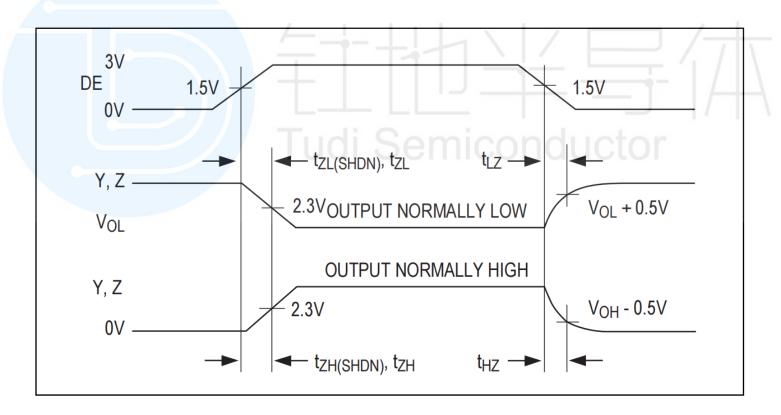


Fig 6 Driver Enable and Disable Times



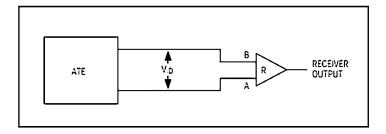


Fig 7Receiver Propagation Delay Test Circuit

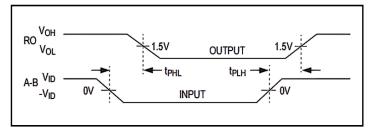
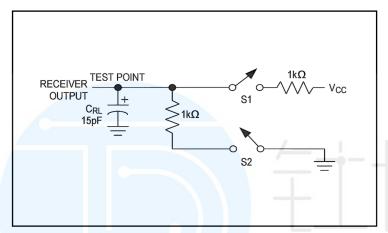


Fig 8 Receiver Propagation Delays



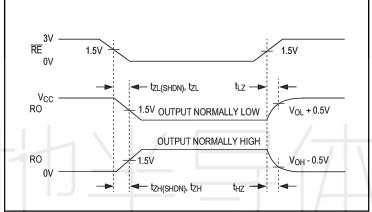


Fig 9 Receiver Enable/Disable Timing Test Load

Fig 10 Receiver Enable and Disable Times

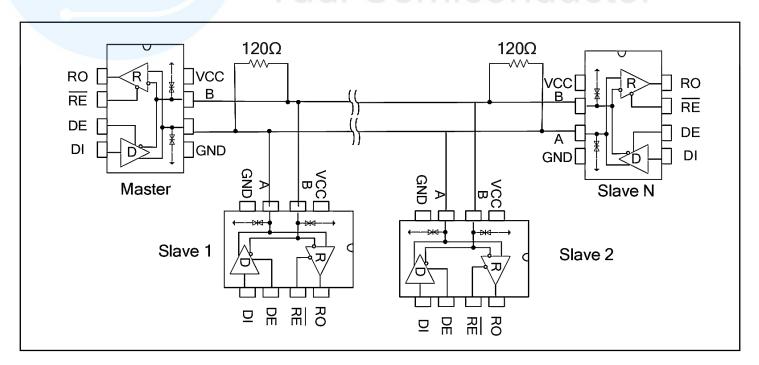


Fig11 Backbone cable type RS485 communications network



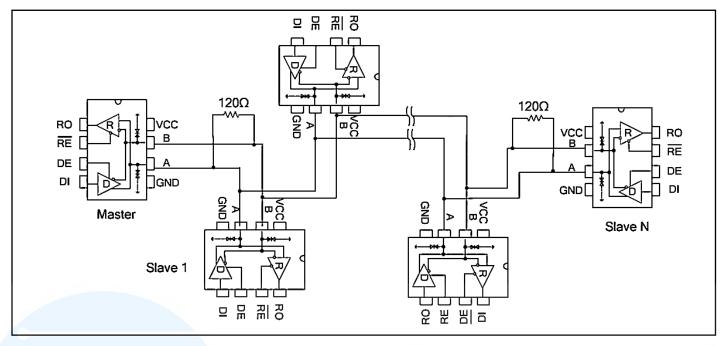


Fig12 Daisy chain topology type RS485 communications network

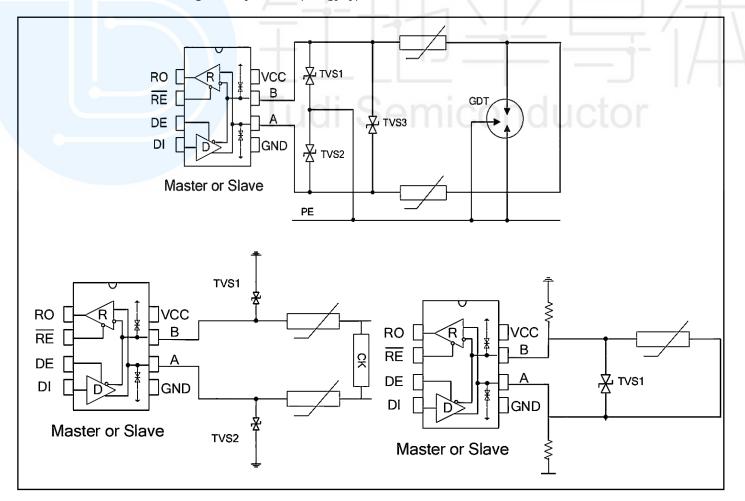


Fig13 RS485 bus ports Protection configuration



Additional description

Description

487E, including a driver and a receiver, is a half-duplex high-speed transceivers for RS485 / RS-422 communications. 487E features fail-safe, overvoltage protection, overcurrent protection, thermal protection, and allows / RE, DE hot-swappable. The 487allows an error-free data transmission up to 250kbps.

Typical Application

Backbone cable type: 487Etransceiver is designed for multi-point bi-directional data communication bus transmission lines. Figure 11 shows a typical network application circuit. These devices can also be used as a cable longer than 4,000 feet of line repeater, to reduce the reflection, the transmission line should be in its ends terminated in its characteristic impedance, and stub lengths off the main line should be as short as possible. Hand in hand type: Also known as daisy chain topology, is the prior RS485 bus topology recommended by the TIA organization. The routing method is the master device and a number of slave devices connected in hand-handle configuration, as shown in Figure 12. It' should be noted at that hand in handle means no branch line. This kind of topology has the advantages of small reflection and high rate of success communicationThe bus port protection: In harsh environments, RS485 communication ports are usually done with static protection, lightning surge protection, and other additional protection, even prepared to prevent 380V electricity access by mistake. To avoid the destruction of intelligent instruments and industrial control host, figure 13 demonstrates three general kinds of RS485 bus port protection configuration.

Connecting 32 Transceivers on one Bus

The standard 487E receiver input impedance is guaranteed >12k , the standard driver can drive up to 32 unit loads. These devices can be any combination, or in combination with other RS485 transceiver combination, as long as the total load does not load more than 32 units, can be connected on the same bus.

Drive Output Protection

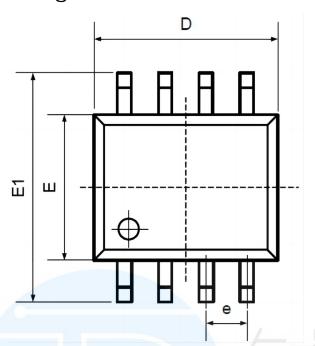
Through two mechanisms to avoid failure or a bus contention causes power consumption is too high. First, in the entire common Mode voltage range, overcurrent protection circuit provides a fast short protection. Second, when the die temperature exceeds 150°C, driver output is forced into a high impedance state by the thermal shutdown circuit.

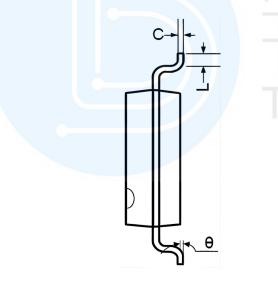
Fail Safe

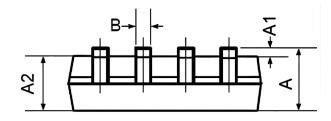
When the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled, 487E guarantees a logic-high receiver output. This is done by the receiver input thresholds are set between -10mV and -200mV. If the differential receiver input voltage (A-B) ≥-10mV, RO is logic high; if the voltage (A-B) ≤-200mV, RO is logic low. When attached to the terminal all transmitters on the bus are disabled, the receiver differential input voltage is pulled to 0V by the termination resistor. With the receiver threshold of the 487E, this results in a logic-high with a 10mV minimum noise margin. The -10mV to -200mV threshold complies with the ±200mV EIA/TIA-485 standard.



Package SOP8



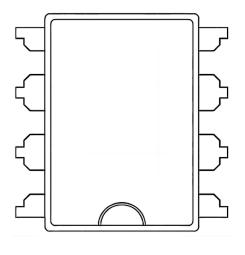


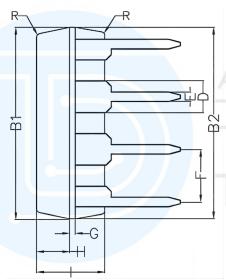


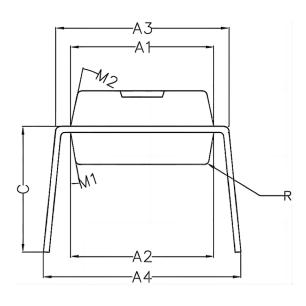
Symbol		nsions meters		nsions ches
Symbol	Min	Max	Min	Max
А	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
В	0.330	0.510	0.013	0.020
С	0.190	0.250	0.007	0.010
Semi	4.780	5.000	0.188	0.197
E	3.800	4.000	0.150	0.157
E1	5.800	6.300	0.228	0.248
e	1.27	ОТҮР	0.05	ОТҮР
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



Package DIP8







Symbol	Min	Non	Max
A1	6.28	6.33	6.38
A2	6.33	6.38	6.43
А3	7.52	7.62	7.72
A4	7.80	8.40	9.00
B1	9.15	9.20	9.25
B2	9.20	9.25	9.30
C		5.57	. 47
D -		1.52	
emic	0.43	0.45	0.47
F		2.54	
G		0.25	
Н	1.54	1.59	1.64
I	3.22	3.27	3.32
R		0.20	
M1	9°	10°	11°
M2	11°	12°	13°



Order information

Order Number	Package	Package Quantity	Marking On The park	Temperature	
MAX487ECPA-TUDI	DIP8	Tube,50,A box of 2000	MAX487ECPA	0°C to 70°C	
MAX487ECSA-TUDI	SOP8	Tape,Reel,2500	MAX487ECSA	00.00700	
MAX487EEPA-TUDI	DIP8	Tube,50,A box of 2000	MAX487EEPA	40°C to 05°C	
MAX487EESA-TUDI	SOP8	Tape,Reel,2500	MAX487EESA	- 40°C to 85°C	





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